

## STGY50NC60WD

#### 50 A, 600 V, ultra fast IGBT

#### **Features**

- Very high frequency operation
- Low C<sub>RES</sub> / C<sub>IES</sub> ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode

#### **Applications**

- Very high frequency inverters, UPS
- HF, SMPS and PFC in both hard switch and resonant topologies
- Motor drivers
- Welding

#### **Description**

This IGBT utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

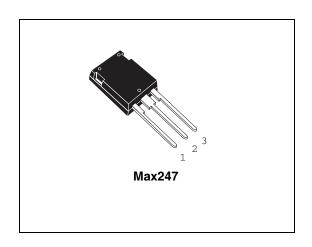


Figure 1. Internal schematic diagram

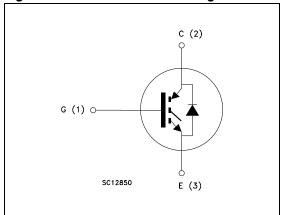


Table 1. Device summary

| Order code   | Marking    | Package | Packaging |
|--------------|------------|---------|-----------|
| STGY50NC60WD | GY50NC60WD | Max247  | Tube      |

Contents STGY50NC60WD

## **Contents**

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STGY50NC60WD Electrical ratings

## 1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol                         | Parameter   | Value      | Unit |
|--------------------------------|---|------------|------|
| V <sub>CES</sub>               | Collector-emitter voltage (V <sub>GE</sub> = 0)                         | 600        | V    |
| I <sub>C</sub> <sup>(1)</sup>  | Collector current (continuous) at T <sub>C</sub> = 25 °C                | 110        | Α    |
| I <sub>C</sub> <sup>(1)</sup>  | Collector current (continuous) at T <sub>C</sub> = 100 °C               | 50         | Α    |
| I <sub>CL</sub> <sup>(2)</sup> | Turn-off latching current   | 180        | Α    |
| I <sub>CP</sub> (3)            | Pulsed collector current  | 180        | Α    |
| I <sub>F</sub>                 | Diode RMS forward current at T <sub>C</sub> = 25 °C                     | 30         | Α    |
| I <sub>FSM</sub>               | Surge not repetitive forward current (t <sub>p</sub> =10 ms sinusoidal) | 120        | А    |
| V <sub>GE</sub>                | Gate-emitter voltage  | ±20        | V    |
| P <sub>TOT</sub>               | Total dissipation at T <sub>C</sub> = 25 °C                             | 278        | W    |
| Tj                             | Operating junction temperature  | -55 to 150 | °C   |

<sup>1.</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2.  $V_{clamp}$  = 80% of  $V_{CES}$ ,  $T_j$  =150 °C,  $R_G$ =10  $\Omega$ ,  $V_{GE}$ =15 V
- 3. Pulse width limited by max. temperature allowed

Table 2. Thermal resistance

| Symbol                | Parameter                                   | Value | Unit |
|-----------------------|---|-------|------|
| R <sub>thj-case</sub> | Thermal resistance junction-case IGBT max.  | 0.45  | °C/W |
| R <sub>thj-case</sub> | Thermal resistance junction-case diode max. | 1.5   | °C/W |
| R <sub>thj-amb</sub>  | Thermal resistance junction-ambient max.    | 50    | °C/W |

Electrical characteristics STGY50NC60WD

## 2 Electrical characteristics

 $(T_{CASE} = 25 \, ^{\circ}C \text{ unless otherwise specified})$ 

Table 3. Static

| Symbol               | Parameter   | Test conditions   | Min. | Тур.       | Max.     | Unit     |
|----------------------|---|---|------|------------|----------|----------|
| V <sub>(BR)CES</sub> | Collector-emitter<br>breakdown voltage<br>(V <sub>GE</sub> = 0) | I <sub>C</sub> = 1 mA   | 600  |            |          | V        |
| V <sub>CE(sat)</sub> | Collector-emitter saturation voltage                            | V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A<br>V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A,T <sub>C</sub> =125 °C |      | 2.1<br>1.9 | 2.6      | V<br>V   |
| V <sub>GE(th)</sub>  | Gate threshold voltage  | $V_{CE} = V_{GE}, I_{C} = 250 \mu A$  | 3.75 |            | 5.75     | V        |
| I <sub>CES</sub>     | Collector cut-off current (V <sub>GE</sub> = 0)                 | V <sub>CE</sub> = 600 V<br>V <sub>CE</sub> = 600 V,T <sub>C</sub> = 125 °C  |      |            | 500<br>5 | μA<br>mA |
| I <sub>GES</sub>     | Gate-emitter leakage current (V <sub>CE</sub> = 0)              | V <sub>GE</sub> = ±20 V   |      |            | ±100     | nA       |
| 9 <sub>fs</sub>      | Forward transconductance  | V <sub>CE</sub> = 15 V <sub>,</sub> I <sub>C</sub> = 40 A   |      | 25         |          | S        |

Table 4. Dynamic

| Symbol   | Parameter   | Test conditions   | Min. | Тур.              | Max. | Unit           |
|--|---|---|------|-------------------|------|----------------|
| C <sub>ies</sub><br>C <sub>oes</sub><br>C <sub>res</sub> | Input capacitance Output capacitance Reverse transfer capacitance | $V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0$  |      | 4700<br>410<br>90 |      | pF<br>pF<br>pF |
| Q <sub>g</sub><br>Q <sub>ge</sub><br>Q <sub>gc</sub>     | Total gate charge Gate-emitter charge Gate-collector charge       | $V_{CE} = 390 \text{ V}, I_{C} = 40 \text{ A},$<br>$V_{GE} = 15 \text{ V},$<br><i>Figure 16</i> |      | 195<br>32<br>82   |      | nC<br>nC<br>nC |

Table 5. Switching on/off (inductive load)

| Symbol  | Parameter   | Test conditions   | Min. | Тур.             | Max. | Unit             |
|---|---|---|------|------------------|------|------------------|
| t <sub>d(on)</sub><br>t <sub>r</sub><br>(di/dt) <sub>on</sub> | Turn-on delay time<br>Current rise time<br>Turn-on current slope  | $V_{CC}$ = 390 V, $I_{C}$ = 40 A<br>$R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V,<br>Figure 17, Figure 15  |      | 52<br>17<br>2400 |      | ns<br>ns<br>A/µs |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>(di/dt) <sub>on</sub> | Turn-on delay time Current rise time Turn-on current slope        | $V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ $T_{C} = 125 ^{\circ}\text{C}$ Figure 17, Figure 15 |      | 50<br>19<br>2020 |      | ns<br>ns<br>A/µs |
| t <sub>r(Voff)</sub> t <sub>d(Voff)</sub> t <sub>f</sub>      | Off voltage rise time<br>Turn-off delay time<br>Current fall time | $V_{CC} = 390 \text{ V}, I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ Figure 17, Figure 15                                 |      | 31<br>240<br>35  |      | ns<br>ns<br>ns   |
| t <sub>r(Voff)</sub> t <sub>d(Voff)</sub> t <sub>f</sub>      | Off voltage rise time<br>Turn-off delay time<br>Current fall time | $V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ $T_{C} = 125 ^{\circ}C$ Figure 17, Figure 15        |      | 59<br>280<br>63  |      | ns<br>ns<br>ns   |

Table 6. Switching energy (inductive load)

| Symbol   | Parameter   | Test conditions   | Min. | Тур.               | Max.               | Unit           |
|--|---|---|------|--------------------|--------------------|----------------|
| E <sub>on</sub> <sup>(1)</sup><br>E <sub>off</sub> <sup>(2)</sup><br>E <sub>ts</sub> | Turn-on switching losses Turn-off switching losses Total switching losses | $V_{CC}$ = 390 V, $I_{C}$ = 40 A<br>$R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V,<br>Figure 15   |      | 365<br>560<br>925  | 470<br>790<br>1260 | μJ<br>μJ<br>μJ |
| E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>       | Turn-on switching losses Turn-off switching losses Total switching losses | $V_{CC} = 390 \text{ V}, I_{C} = 40 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{C} = 125 ^{\circ}\text{C}$ Figure 15 |      | 635<br>910<br>1545 |                    | μJ<br>μJ<br>μJ |

Eon is the tun-on losses when a typical diode is used in the test circuit in Figure 18 If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

<sup>2.</sup> Turn-off losses include also the tail of the collector current

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Table 7. Collector-emitter diode

| Symbol   | Parameter  | Test conditions  | Min. | Тур.              | Max. | Unit          |
|--|--|--|------|-------------------|------|---------------|
| V <sub>F</sub>   | Forward on-voltage   | I <sub>F</sub> = 40 A<br>I <sub>F</sub> = 40 A, T <sub>C</sub> = 125 °C  |      | 3.2<br>2.2        |      | V<br>V        |
| t <sub>rr</sub><br>Q <sub>rr</sub><br>I <sub>rrm</sub> | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_F = 40 \text{ A,V}_R = 50 \text{ V,}$<br>di/dt = 100 A/ $\mu$ s<br>Figure 18  |      | 55<br>100<br>3.6  |      | ns<br>nC<br>A |
| t <sub>rr</sub><br>Q <sub>rr</sub><br>I <sub>rrm</sub> | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_F = 40 \text{ A,V}_R = 50 \text{ V,}$ $T_C = 125 ^{\circ}\text{C,}$ $di/dt = 100 \text{ A/}\mu\text{s} (Figure 18)$ |      | 164<br>525<br>6.4 |      | ns<br>nC<br>A |

## 2.1 Electrical characteristics (curves)

Figure 1. Output characteristics

Figure 2. Transfer characteristics

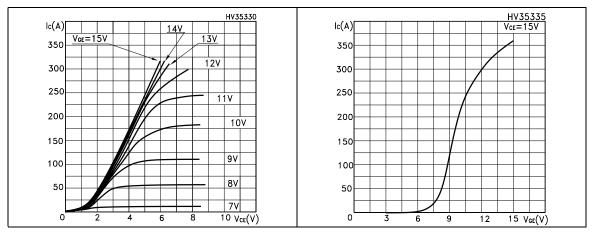


Figure 3. Transconductance

Figure 4. Collector-emitter on voltage vs temperature

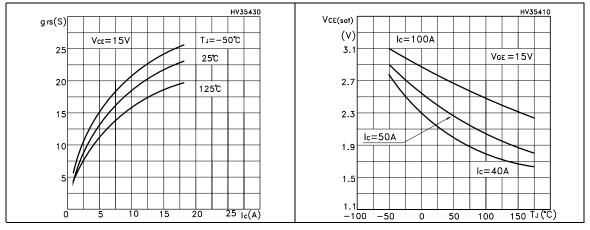
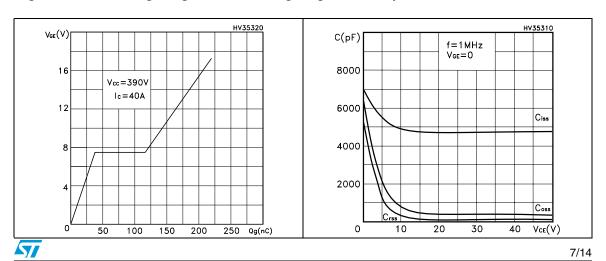


Figure 5. Gate charge vs gate-source voltage Figure 6. Capacitance variations



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Figure 7. Normalized gate threshold voltage Figure 8. Collector-emitter on voltage vs vs temperature collector current

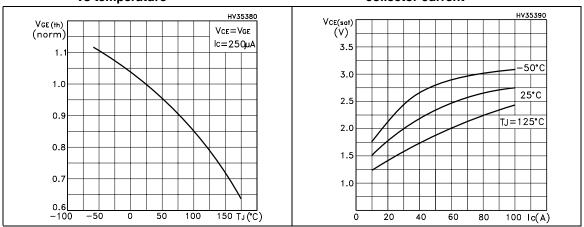


Figure 9. Normalized breakdown voltage vs Figure 10. Switching losses vs temperature temperature

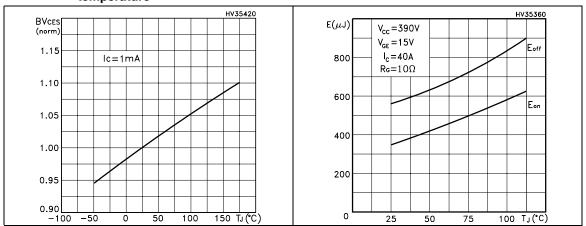
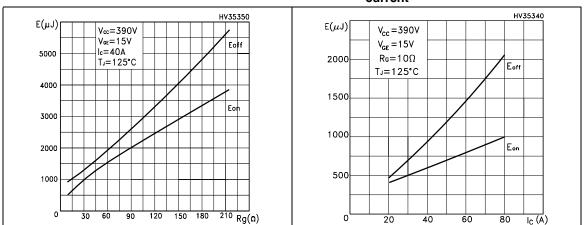


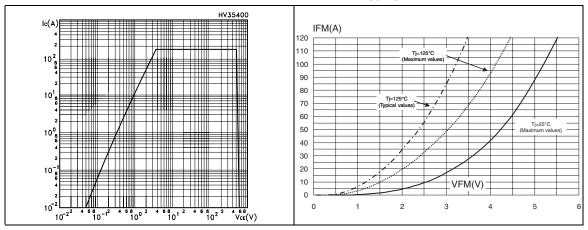
Figure 11. Switching losses vs gate resistance Figure 12. Switching losses vs collector current



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Figure 13. Turn-off SOA

Figure 14. Forward voltage drop vs. forward current



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Test circuit STGY50NC60WD

## 3 Test circuit

Figure 15. Test circuit for inductive load switching

Figure 16. Gate charge test circuit

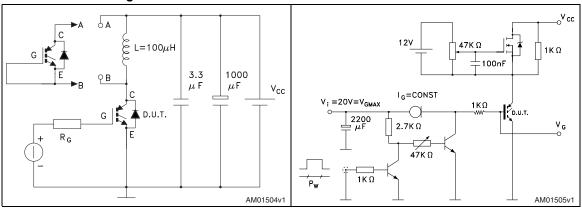
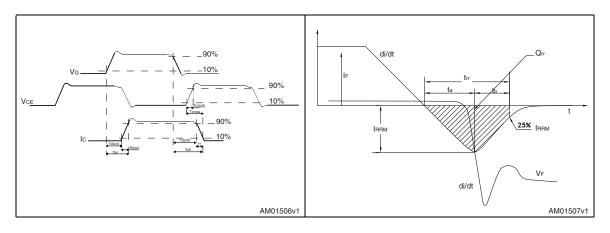


Figure 17. Switching waveform

Figure 18. Diode recovery time waveform



## 4 Package mechanical data

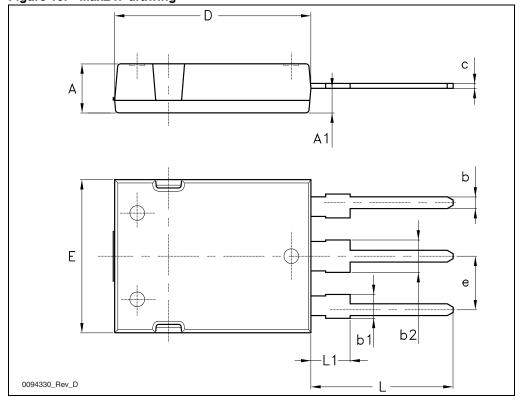
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

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Table 8. Max247 mechanical data

| Dim.   |       | mm   |       |
|--------|-------|------|-------|
| Dilli. | Min.  | Тур. | Max.  |
| А      | 4.70  |      | 5.30  |
| A1     | 2.20  |      | 2.60  |
| b      | 1.00  |      | 1.40  |
| b1     | 2.00  |      | 2.40  |
| b2     | 3.00  |      | 3.40  |
| С      | 0.40  |      | 0.80  |
| D      | 19.70 |      | 20.30 |
| е      | 5.35  |      | 5.55  |
| E      | 15.30 |      | 15.90 |
| L      | 14.20 |      | 15.20 |
| L1     | 3.70  |      | 4.30  |

Figure 19. Max247 drawing



STGY50NC60WD Revision history

# 5 Revision history

Table 9. Document revision history

| Date        | Revision | Changes  |
|-------------|----------|--|
| 09-Oct-2006 | 1        | Initial release.   |
| 07-May-2007 | 2        | Complete version   |
| 02-Jul-2007 | 3        | Modified value on Table 2: Thermal resistance                                    |
| 04-Nov-2008 | 4        | Table 8: Max247 mechanical data and Figure 19: Max247 drawing have been updated. |
| 09-Jan-2009 | 5        | Figure 13: Turn-off SOA has been updated.  |

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